AZ DISPLAYS

SPECIFICATIONS FOR
LIQUID CRYSTAL DISPLAY

CUSTOMER APPROVAL

※ **PART NO. :** ATM0700M61K (AZ DISPLAYS) SPEC V1.0

APPROVAL		COMPANY CHOP	
CUSTOMER COMMENTS			

AZ DISPLAYS ENGINEERING APPROVAL		
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REVISION RECORD

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V1.0	2022-07-25	--	FIRST ISSUE

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1. GENERAL SPECIFICATIONS

Item	Specification	Remark
1. LCD size	7.0 inch(Diagonal)	
2. Driver element	a-Si TFT active matrix	
3. Resolution	1024x(RGB)x600	
4. Display mode	Normally black, IPS, Transmissive	
5. Dot Pitch (W*H)	0.0502mm(W) x 0.1432mm(H)	
6. Pixel pitch(W*H)	0.1506mm(W) x 0.1432mm(H)	
7. Active Area(W*H)	154.21mm(W) x 85.92mm(H)	
8. Module size (W*H)	164.9mm(W) x 100.0mm(H) x 5.7mm(D)	Note 1
9. Surface treatment	Anti-glare	
10. Color arrangement	RGB-stripe	
11. Color	16.7M	
12. Viewing angle (L/R/T/B)	80/80/80/80	
13. Interface	2/3/4 lane MIPI interface	
14. LCD controller	EK79007+EK73217A	
15. LCM brightness	1100 cd/m2 (Typ.)	
16. Backlight driving condition	480mA @9.0V	
17. Touch panel	N.A.	
18. Touch controller	N.A.	
19. Operation temperature	-20~70 ºC	
20. Weight	151g(Typ.)	
21. RoHS	RoHS compliant	

Note 1: **Please refer to mechanical drawing.**

2. PIN ASSIGNMENT

TFT LCD Panel Driving Section

FPC Connector is used for the module electronics interface. The recommended model is
HIROSE FH33J-40S-0.5SH(10), MOLEX 0541044031 or compatible.

Pin No.	Symbol	Function	Level	Note
1	VCOM	Common voltage	P	
2~3	VDD	Power voltage, 3.3V typical	P	
4	NC	No connection	-	
5	RESET	Global reset pin, 0V RESET, 3.3V for normal use.	I	
6	STBYB	Standby mode, normally pulled high STBYB = 3.3V ,normal operation ; STBYB = 0 ,display shutdown	I	
7	GND	Ground	P	
8	D0N	-MIPI differential data input 0	I	
9	D0P	+MIPI differential data input 0	I	
10	GND	Ground	P	
11	D1N	-MIPI differential data input 1	I	
12	D1P	+MIPI differential data input 1	I	
13	GND	Ground	P	
14	CLKN	-MIPI differential clock input	I	
15	CLKP	+MIPI differential clock input	I	
16	GND	Ground	P	
17	D2N	-MIPI differential data input 2	I	
18	D2P	+MIPI differential data input 2	I	
19	GND	Ground	P	
20	D3N	-MIPI differential data input 3	I	
21	D3P	+MIPI differential data input 3	I	
22	GND	Ground	P	
23~24	NC	No connection	-	
25	GND	Ground	P	
26~28	NC	No connection	-	
29	AVDD	Power for analog circuit	P	
30	GND	Ground	P	
31~32	LED-	LED cathode	P	
33	L/R	Horizontal inversion SHLR = 0V, shift left: SHLR = 3.3V, shift right:	I	
34	U/D	Vertical inversion SHLR = 0V, shift down: SHLR = 3.3V, shift up:	I	
35	VGL	Gate off voltage	P	
36~37	GND	Ground	P	
38	VGH	Gate on voltage	P	
39~40	LED+	LED anode	P	

I: input, O: output, P: Power

3. Operating Specification

3.1 ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Values		Unit	Remark
		Min.	Max.		
Power Voltage	V_{DD}	-0.5	3.96	V	
	AV_{DD}	-0.5	14.85	V	
	V_{GH}	-0.3	42	V	
	V_{GL}	-42	0.3	V	
Operation Temperature	T_{OP}	-20	70	ºC	
Storage Temperature	T_{ST}	-30	80	ºC	
LED Reverse Voltage	V_R	-	1.2	V	Each LED Note 2
LED Forward Current	I_F		25	mA	Each LED

Note 1: The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

Note 2: V_R Conditions: Zener Diode 20mA

3.1.1 Typical Operation Conditions

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Power Voltage	V_{DD}	3.0	3.3	3.6	V	
	AV_{DD}	9.4	9.6	9.8	V	
	V_{GH}	17.5	18.0	18.5	V	
	V_{GL}	-6.5	-6	-5.5	V	
Input Signal Voltage	V_{COM}	2.3	3.5	4.2	V	
Input Logic High Voltage	V_{IH}	$0.7DV_{DD}$	--	DV_{DD}	V	
Input Logic Low Voltage	V_{IL}	0	--	$0.3DV_{DD}$	V	

Note 1: Be sure to apply V_{DD} and V_{GL} to the LCD first, and then apply V_{GH}.

3.1.2 Current Consumption

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Power Voltage	I_{GH}	--	5.2	10.2	mA	V_{GH}=18.0V
	I_{GL}	--	4.7	9.7	mA	V_{GL}=-6.0V
	I_{VDD}	--	14	19	mA	V_{DD}=3.3V
	I_{AVDD}	--	31.0	50.0	mA	AV_{DD}=9.6V

3.1.3 Backlight driving conditions

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Voltage for LED Backlight	V_L	7.8	9.0	10.2	V	Note 1
Current for LED Backlight	I_L	-	480	-	mA	
LED life time	--	30000	--	--	Hr	Note 2

Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25℃ and I_L =480mA.

Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25℃ and I_L =480mA.

ILED VS TEMP
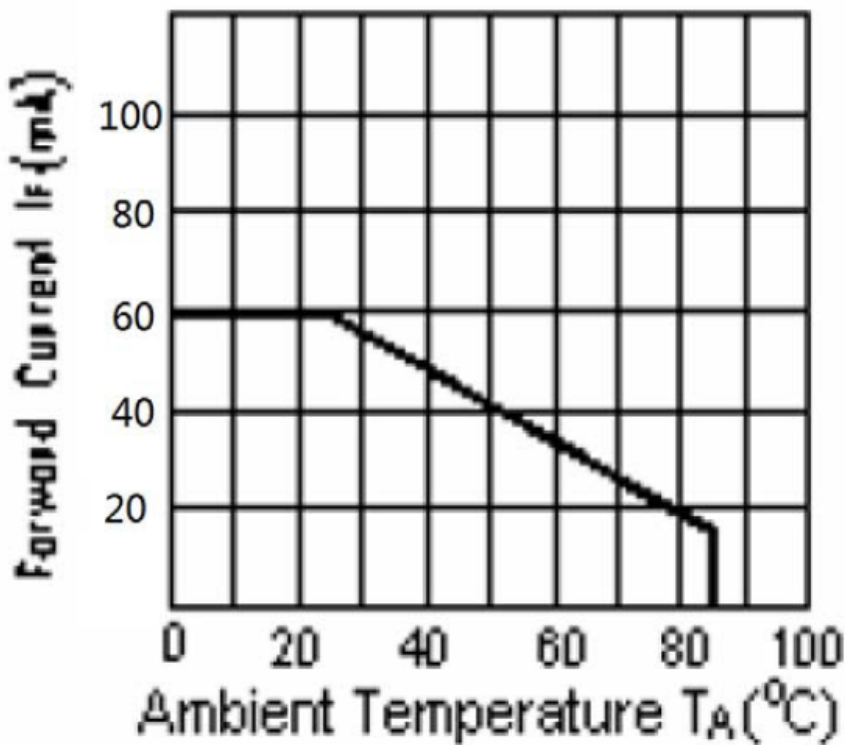
3.2 Power Sequence

a.Power on:
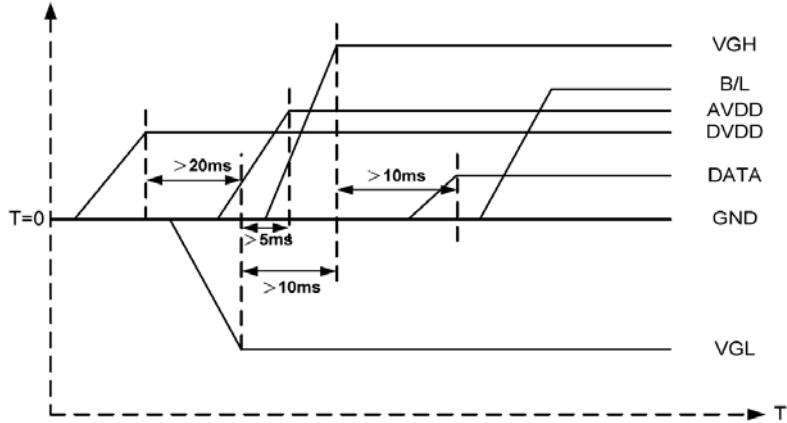
$V_{DD} \rightarrow V_{GL} \rightarrow V_{GH} \rightarrow Data \rightarrow B/L$

b.Power off:
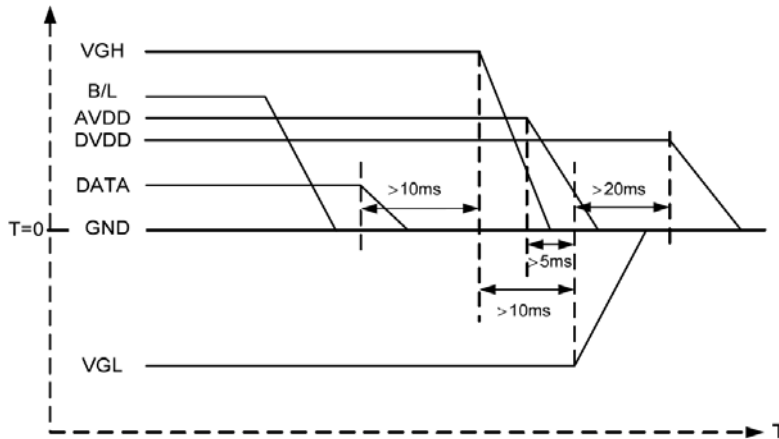

$B/L \rightarrow Data \rightarrow V_{GH} \rightarrow V_{GL} \rightarrow V_{DD}$

3.3 Timing Characteristics

3.3.1 DC Electrical Characteristics

VDD=3.3V TA=-20~70°

Parameter	Symbol	Min.	Typ.	Max.	Unit
MIPI Characteristics for High Speed Receiver					
Single-ended input low voltage	V_{ILHS}	-40	-	-	mV
Single-ended input high voltage	V_{IHHS}	-	-	460	mV
Common-mode voltage	V_{CDRXDC}	70	-	330	mV
Differential input impedance	Z_{ID}		100		ohm
HS transmit differential voltage(VOD=VDP-VDN)	$|V_{OD}|$	140	200	250	mV
MIPI Characteristics for Low Power Mode					
Pad signal voltage range	V_I	-50	-	1350	mV
Ground shift	V_{GNDSH}	-50	-	50	mV
Logic 0 input threshold	V_{IL}	0	-	550	mV
Logic 1 input threshold	V_{IH}	880	-	1350	mV
Input hysteresis	V_{HYST}	25	-	-	mV
Output low level	V_{OL}	-50	-	50	mV
Output high level	V_{OH}	1.1	1.2	1.3	V
Output impedance of Low Power Transmitter	Z_{OLP}	80	100	125	ohm
Logic 0 contention threshold	$V_{ILCD,MAX}$	-	-	200	mV
Logic 0 contention threshold	$V_{IHCD,MIN}$	450	-	-	mV
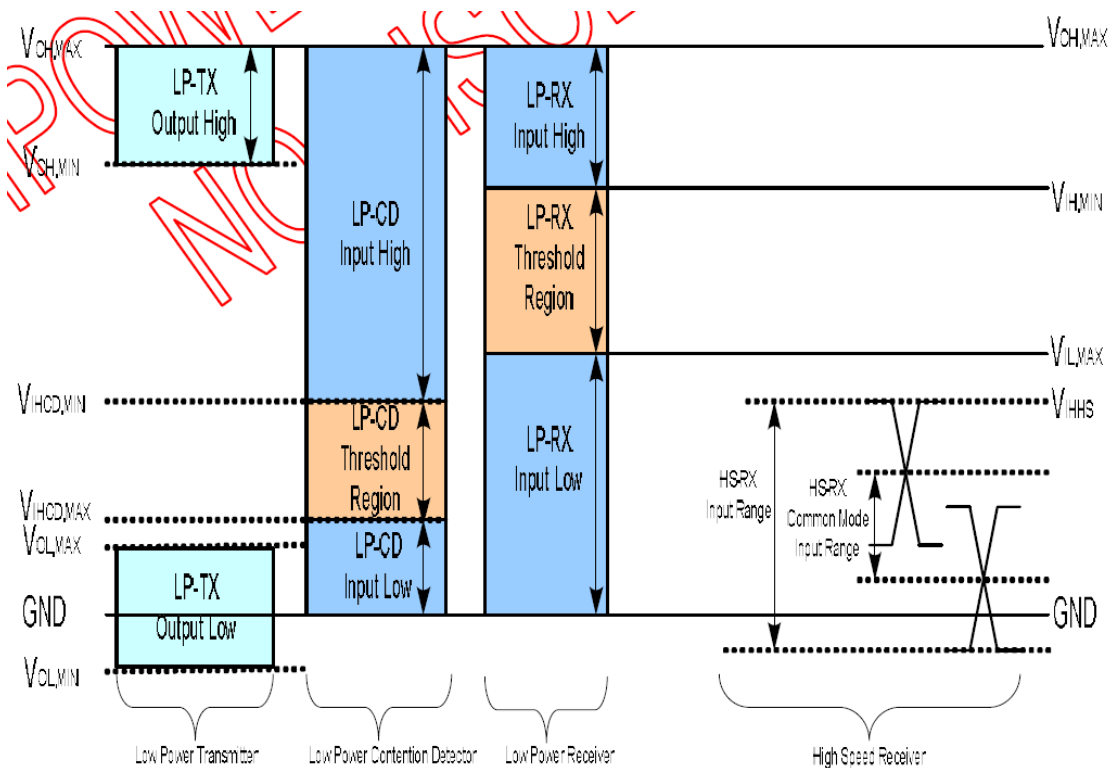
3.3.2 Timing

Refer to IC specifications

4.0 OPTICAL SPECIFICATIONS

Item	Symbol	Condition	Values			Unit	Remark
			Min.	Typ.	Max.		
Viewing Angle (CR≥10)	θ_L	Φ=180°(9 O'CLOCK)	70	80	--	degree	Note 1
	θ_R	Φ=0°(3 O'CLOCK)	70	80	--		
	θ_T	Φ=90°(12 O'CLOCK)	70	80	--		
	θ_B	Φ=270°(6 O'CLOCK)	70	80	--		
Response Time	T_{ON+} T_{OFF}		--	30	--	msec	Note 3
Contrast Ratio	CR		600	800	--	--	Note 4
Color Chromaticity	W_X	Normal Θ=Φ=0°	0.26	0.31	0.36	--	Note 2 Note 5
	W_Y		0.28	0.33	0.38	--	Note 6
Luminance	L		900	1100	--	cd/m^2	Note 6
Luminance Uniformity	YU		75	80	--	%	Note 7

Test Conditions:
1. IL=480mA (Backlight current), the ambient temperature is 25℃.
2. The test systems refer to Note 2.

Note 1: Definition of viewing angle range
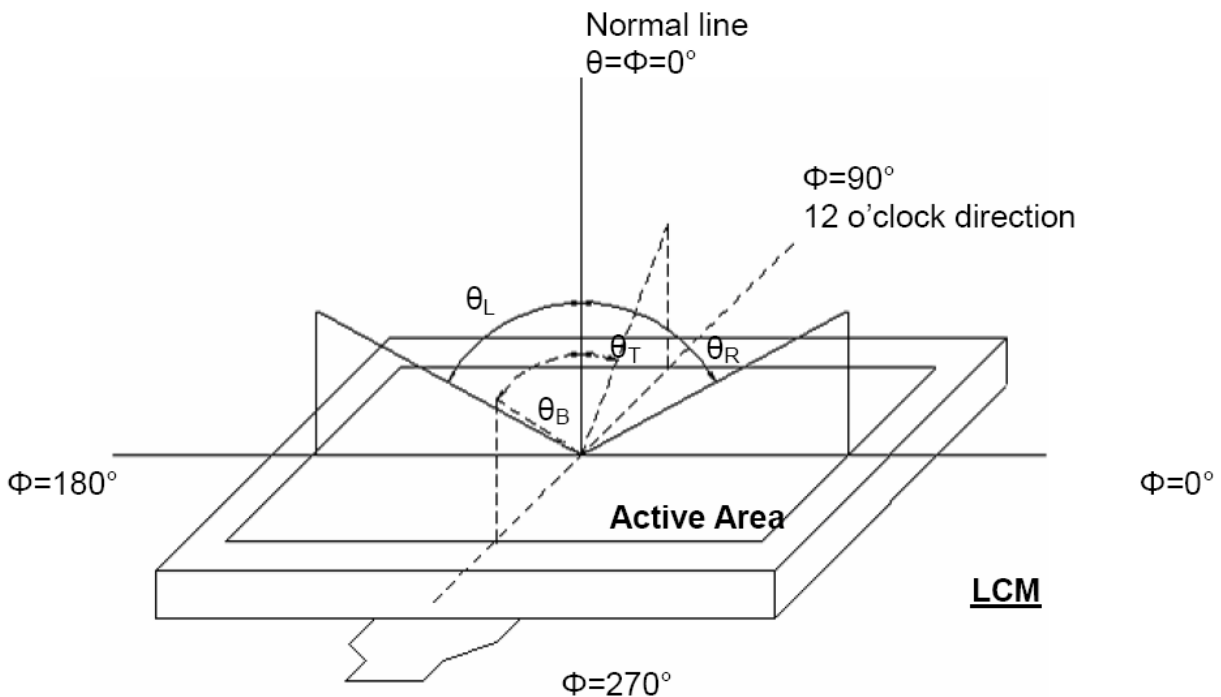
Figure 4.1 Definition of viewing angle.

Note 2: Definition of optical measurement system.
The optical characteristics should be measured in dark room. After 30 minutes operation, the optical properties are measured at the center point of the LCD screen. (Response time is measured by Photo detector TOPCON
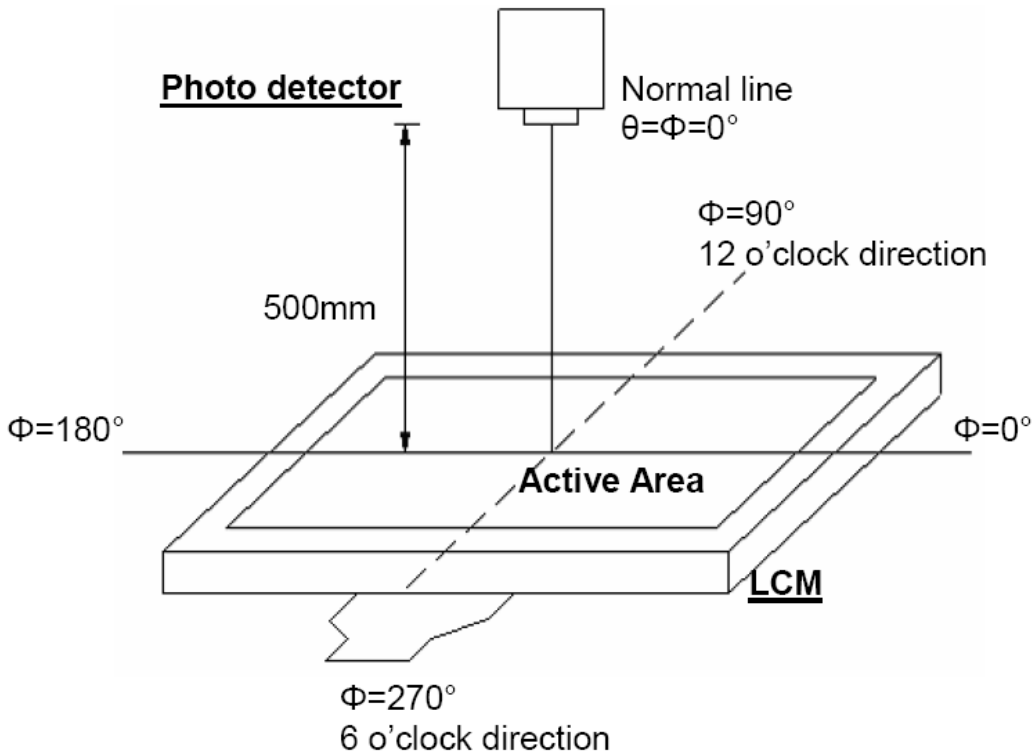

Figure 4.2 Optical measurement system setup

Note 3: Definition of Response time
The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (TON) is the time between photo detector output intensity changed from 90% to 10%. And fall time (TOFF) is the time between photo detector output intensity changed from 10% to 90%.
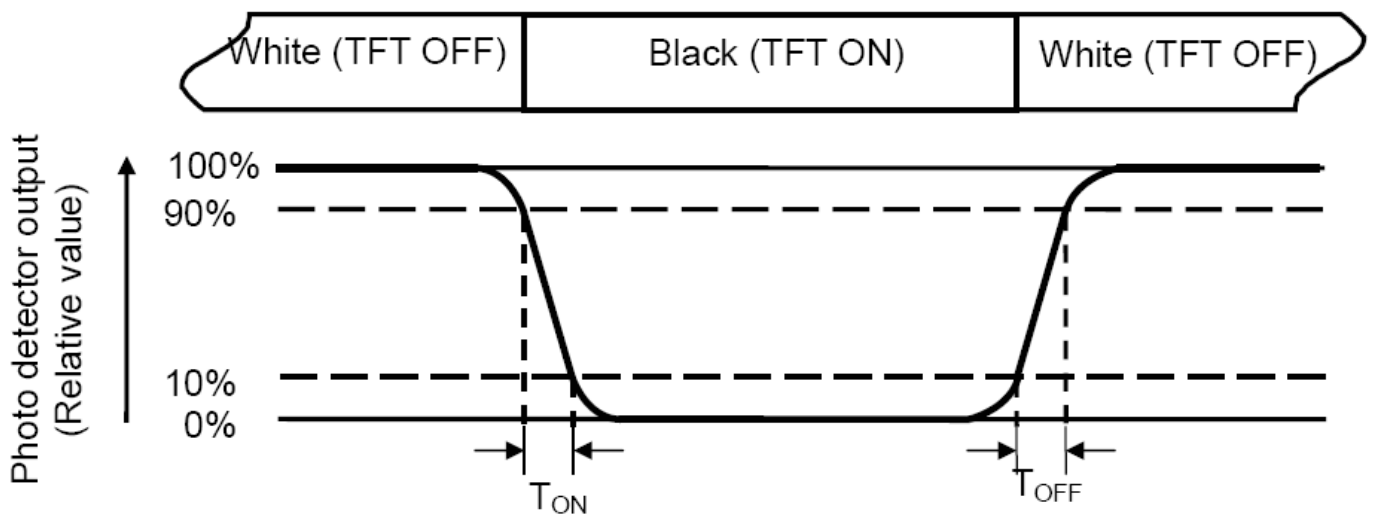
Figure 4.3 Definition of response.

Note 4: Definition of contrast ratio

$$Contrast\ ratio(CR) = \frac{Luminance\ measured\ when\ LCD\ on\ the\ "white"\ state}{Luminance\ measured\ when\ LCD\ on\ the\ "black"\ state}$$

Note 5: Definition of color chromaticity (CIE1931)
Color coordinates measured at center point of LCD.
Note 6: All input terminals LCD panel must be ground while measuring the center area of the panel.
Note 7: Definition of Luminance Uniformity
Active area is divided into 9 measuring areas (Refer to Fig. 4.4).Every measuring point is placed at the center of each measuring area.

$$Luminance\ Uniformity\ (Yu) = \frac{B_{min}}{B_{max}}$$

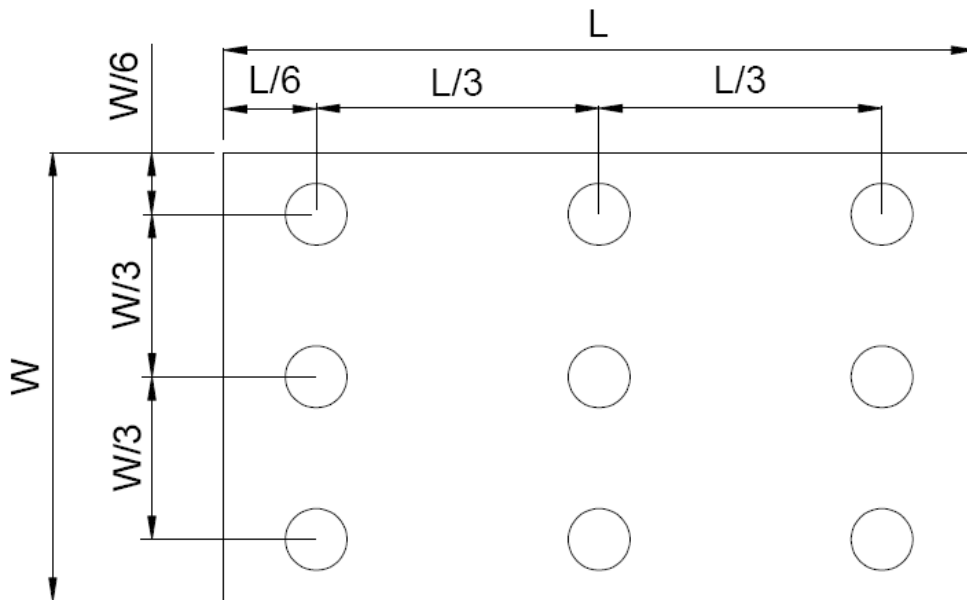L-------Active area length   W----- Active area width

Figure 4.4 Definition of measuring points.

Bmax: The measured maximum luminance of all measurement position.
Bmin: The measured minimum luminance of all measurement position.

5. RELIABILITY TEST

Item	Test Condition Item	Remark
High temperature storage	Ta= 80 ℃ 96hrs	Note 1 Note 3
Low temperature storage	Ta=-30 ℃ 96hrs	Note 1 Note 3
High temperature operation	Ts= 70 ℃ 96hrs	Note 2 Note 3
Low temperature operation	Ts=-20 ℃ 96hrs	Note 1 Note 3
High temperature/High humidity operation	90% RH 60℃ 96hrs	Note 3
Thermal Shock	-30℃/30 min ~ +80℃/30 min for a total 10 cycles, Start with cold temperature and end with high temperature.	Note 3
Vibration test	Freq:10~55~10Hz Amplitude:1.5mm 30 minutes for each direction of X,Y,Z	
Package drop test	Height:60 cm 1 corner, 3 edges, 6 surfaces	
Electro static discharge	± 2KV, Human Body Mode, 100pF/1500Ω	

Note 1: Ta is the ambient temperature of samples.
Note 2: Ts is the temperature of panel's surface.
Note 3: Before cosmetic and function test, the product must have enough recovery time, at least 2 hours at room temperature.

6. PRECAUTION FOR USING LCM

1. When design the product with this LCD Module, make sure the viewing angle matches to its purpose of usage.
2. As LCD panel is made of glass substrate, Dropping the LCD module or banging it against hard objects may cause cracking or fragmentation. Especially at corners and edges.
3. Although the polarizer of this LCD Module has the anti-glare coating, always be careful not to scratch its surface. Use of a plastic cover is recommended to protect the surface of polarizer.
4. If the LCD module is stored at below specified temperature, the LC material may freeze and be deteriorated. If it is stored at above specified temperature, the molecular orientation of the LC material may change to Liquid state and it may not revert to its original state. Excessive temperature and humidity could cause polarizer peel off or bubble. Therefore, the LCD module should always be stored within specified temperature range.
5. Saliva or water droplets must be wiped off immediately as those may leave stains or cause color changes if remained for a long time. Water vapor will cause corrosion of ITO electrodes.
6. If the surface of LCD panel needs to be cleaned, wipe it swiftly with cotton or other soft cloth. If it is not still clean enough, blow a breath on the surface and wipe again.
7. The module should be driven according to the specified ratings to avoid malfunction and permanent damage. Applying DC voltage cause a rapid deterioration of LC material. Make sure to apply alternating waveform by continuous application of the M signal. Especially the power ON/OFF sequence should be kept to avoid latch-up of driver LSIs and DC charge up to LCD panel.
8. Mechanical Considerations
   a) LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.
   b) Do not tamper in any way with the tabs on the metal frame.
   c) Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattern.
9. Static Electricity
   a) Operator

Wear the electrostatics shielded clothes because human body may be statically charged if not ware shielded clothes. Never touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.

   b) Equipment

There is a possibility that the static electricity is charged to the equipment, which has a function of peeling or friction action (ex: conveyer, soldering iron, working table). Earth the equipment through proper resistance (electrostatic earth: 1×10^8 ohm).
Only properly grounded soldering irons should be used.
If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.
The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended.

   c) Floor

Floor is the important part to drain static electricity, which is generated by operators or equipment.
There is a possibility that charged static electricity is not properly drained in case of insulating floor. Set the electrostatic earth (electrostatic earth: 1×10^8 ohm).

   d) Humidity

Proper humidity helps in reducing the chance of generating electrostatic charges. Humidity should be kept over 50%RH.

   e) Transportation/storage

The storage materials also need to be anti-static treated because there is a possibility that the human body or storage materials such as containers may be statically charged by friction or peeling.
The modules should be kept in antistatic bags or other containers resistant to static for storage.

   f) Soldering

Soldering anything to this TFT display would void the warranty.

   g) Others

The laminator (protective film) is attached on the surface of LCD panel to prevent it from scratches or stains. It should be peeled off slowly using static eliminator.
Static eliminator should also be installed to the workbench to prevent LCD module from static charge.
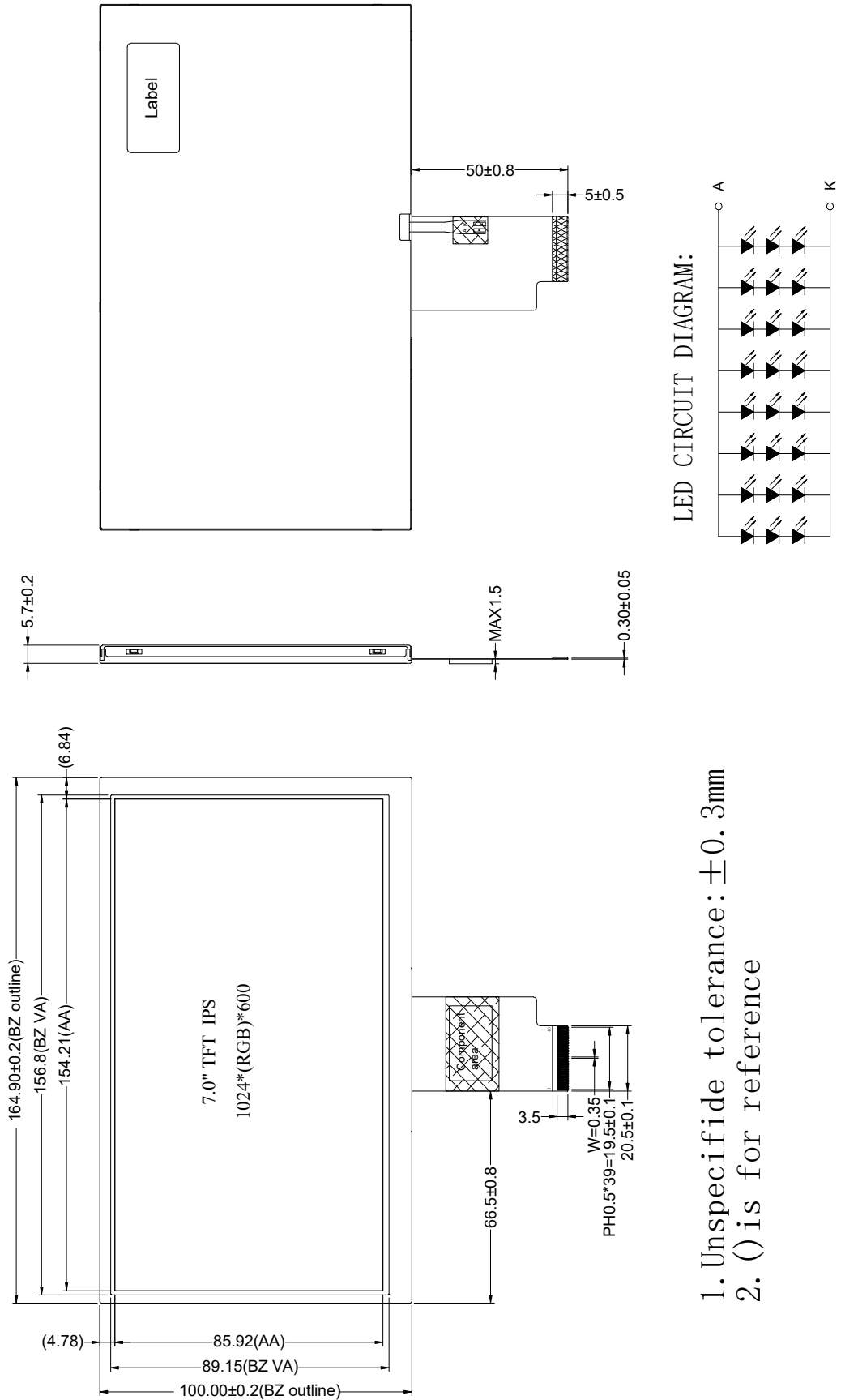
10. Operation
    a) Driving voltage should be kept within specified range; excess voltage shortens display life.
    b) Response time increases with decrease in temperature.
    c) Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".
    d) Mechanical disturbance during operation (such as pressing on the viewing area) may cause the segments to appear "fractured".
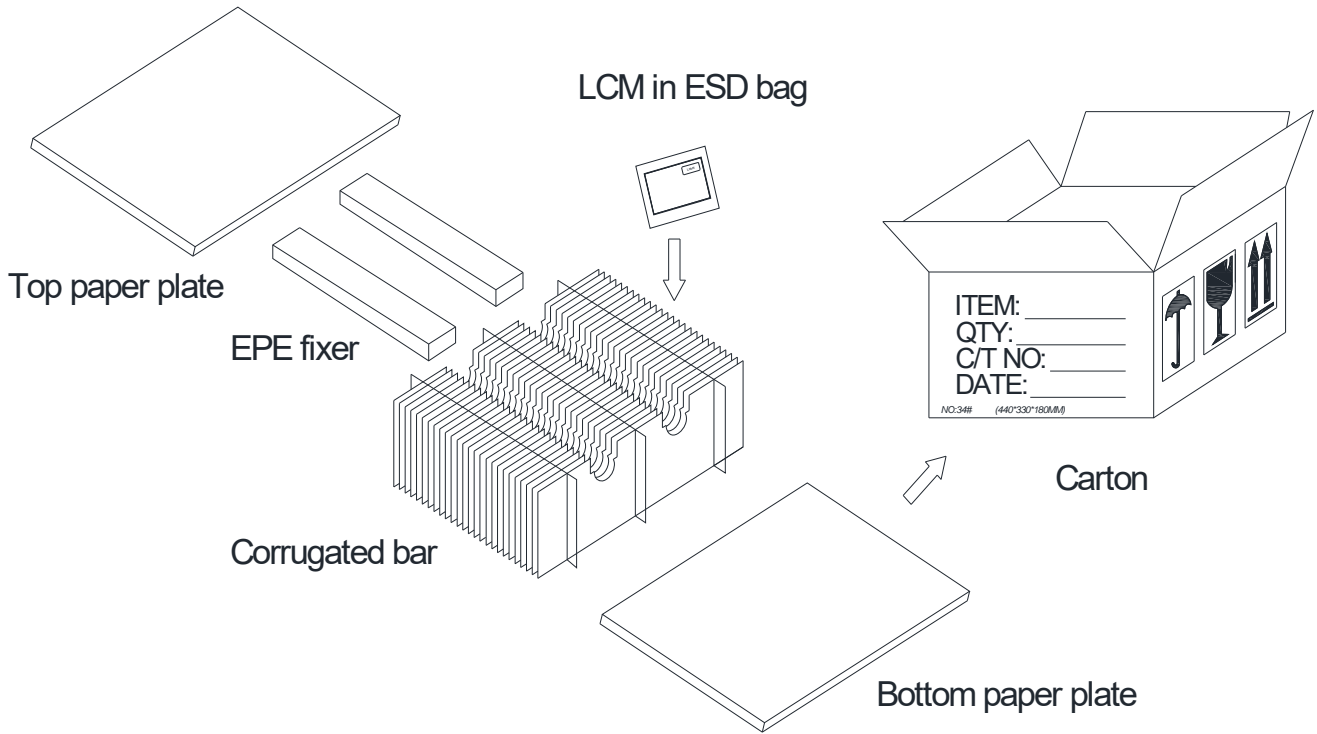
11. If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. The toxicity is extremely low but caution should be exercised at all the time.

12. Disassembling the LCD module can cause permanent damage and it should be strictly avoided.

13. LCD retains the display pattern when it is applied for long time (Image retention). To prevent image retention, do not apply the fixed pattern for a long time. Image retention is not a deterioration of LCD. It will be removed after display pattern is changed.

14. Do not use any materials, which emit gas from epoxy resin (hardener for amine) and silicone adhesive agent (dealcohol or deoxym) to prevent discoloration of polarizer due to gas.

15. Avoid the exposure of the module to the direct sunlight or strong ultraviolet light for a long time.

7. MECHANICAL DRAWING

50±0.8

5±0.5

LED CIRCUIT DIAGRAM:

A

K

Label

5.7±0.2

MAX1.5

0.30±0.05

(6.84)

164.90±0.2(BZ outline)

156.8(BZ VA)

154.21(AA)

7.0" TFT IPS
1024*(RGB)*600

66.5±0.8

Component area

3.5

W=0.35

PH0.5*39=19.5±0.1

20.5±0.1

(4.78)

85.92(AA)

89.15(BZ VA)

100.00±0.2(BZ outline)

1.Unspecifide tolerance:±0.3mm
2.()is for reference

8. PACKAGE DRAWING

Carton size	44x34x18	cm
Quantity per carton	40	pcs

9. INSPECTION SPECIFICATION

1. SCOPE SPECIFICATIONS CONTAIN
   1.1 DISPLAY QUALITY EVALUATION
   1.2 MECHANICS SPECIFICATION

2. SAMPLING PLAN
   UNLESS THERE IS OTHER AGREEMENT, THE SAMPLING PLAN FOR INCOMING INSPECTION SHALL FOLLOW MIL-STD-105E.
   2.1 LOT SIZE: QUANTITY PER SHIPMENT AS ONE LOT (DIFFERENT MODEL AS DIFFERENT LOT).
   2.2 SAMPLING TYPE: NORMAL INSPECTION, SINGLE SAMPLING.
   2.3 SAMPLING LEVEL: LEVEL II.
   2.4 AQL: ACCEPTABLE QUALITY LEVEL
           MAJOR DEFECT: AQL=0.65
           MINOR DEFECT: AQL=1.0

3. PANEL INSPECTION CONDITION
   3.1 ENVIRONMENT:
       ROOM TEMPERATURE: 25±5°C.
       HUMIDITY: 65±5% RH.
       ILLUMINATION: 300 ~ 700 LUX.
   3.2 INSPECTION DISTANCE:
       35±5 CM
   3.3 INSPECTION ANGLE:
       THE VISION OF INSPECTOR SHOULD BE PERPENDICULAR TO THE SURFACE OF THE MODULE.
   3.4 INSPECTION TIME：
   PERCEPTIBILITY TEST TIME: 20 SECONDS MAX.

4. DISPLAY QUALITY
   4.1 FUNCTION RELATED:
       THE FUNCTION DEFECTS OF LINE DEFECT, ABNORMAL DISPLAY, AND NO DISPLAY ARE CONSIDERED MAJOR DEFECTS.
   4.2 BRIGHT/DARK DOTS:

Defect Type	Specification	Major	Minor
Bright Dots	N≤ 2		●
Dark Dots	N≤ 3		●
Total Bright and Dark Dots	N≤ 4		●

Note: 1:
   The definition of dot: The size of a defective dot over 1/2 of whole dot is regarded as one defective dot.
   Bright dot: Dots appear bright and unchanged in size in which LCD panel is displaying under black pattern.
   The bright dot defect must be visible through 2% ND filter
   Dark dot: Dots appear dark and unchanged in size in which LCD panel is displaying under pure red, green, blue pattern.
   4.3 Pixel Definition:

R	G	B	R	G	B	R	G	B			Dot Defect
R	G	B	R	G	B	R	G	B			Adjacent Dot Defect
R	G	B	R	G	B	R	G	B			Cluster

   Note 1:
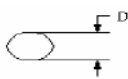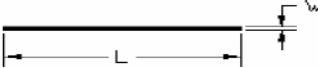   If pixel or partial sub-pixel defects exceed 50% of the affected pixel or sub-pixel area, it shall be considered as1 defect.
   Note 2:
       There should be no distinct non-uniformity visible through 2% ND Filter within 2 sec inspection times.

4.4Visual Inspection specifications:

Defect Type		Specification Size	Count(N)	Major	Minor
Dot Shape (Particle、Scratch and Bubbles in display area)		D ≤0.25 mm	Ignored		●
		0.25mm < D ≤ 0.5mm	N ≤ 3		
		D > 0.5mm	N=0		
Newton Ring (Only for Touch panel)		D≤70mm	N≤4		●
		D>70mm	N=0		
TSP Fish Eyes (Only for Touch panel) (Bubble/Dent)		0.1mm<D≤0.2mm	N≤4		●
		0.2mm<D≤0.3mm	N≤3		
		0.3<D≤0.4	N≤2		
Line Shape (Particles、Scratch、Lint and Bubbles in display area)		W ≤ 0.01 mm	Ignored		●
		0.01mm< W ≤ 0.05mm and L ≤ 3mm	N ≤ 3		
		W > 0.05mm or L > 3 mm	N=0		
Bubble in cell (active area)		It should be found by eyes			●
Bezel	Scratch	No harm			●
	Dirt				●
	Wrap	No harm			●
	Sunken	No harm			●
Label	No label	No			●
	Inverted label				●
	Broken				●
	Dirt	Word can be read.			●
	Not clear	No			●
	Word out of shape				●
	Mistake	No			●
	Position	Be attached on right position			●
Screw	Not enough	No			●
	Limp	No			●

Connector	Connection status	No bend on pins and damage		●
FPC/FFC	Broken	No		●

Note: Extraneous substance and scratch not affecting the display of image, for instance, extraneous substance under polarizer film but outside the display area, or scratch on metal bezel and backlight module or polarizer film outside the display area, shall not be considered as defective or non-conforming.